# Zener diode

# VDZ36B

## Application

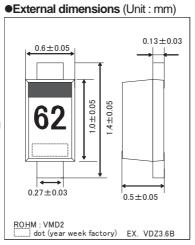
Voltage regulation

#### Features

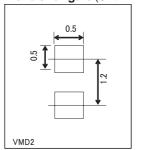
- 1) Ultra small mold type (VMD2).
- 2) High reliability.
- 3) By chip-mounter, automatic mounting is possible.

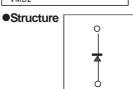
#### Construction

Silicon Epitaxial Planer

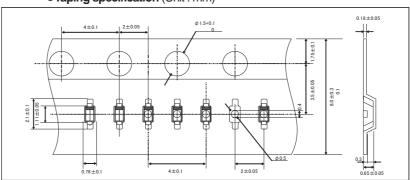


●Land size figure (Unit : mm)





● Taping specification (Unit: mm)



● Absolute maximum ratings (Ta=25°C)

Absolute maximum ratings (Ta=25°C)				
Parameter	Symbol	Limits	Unit	
Power dissipation	Р	100	mW	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	
Operating temperature	Topr	-55 to +150	°C	

# Diodes

●Electrical characteristics (Ta=25°C)									
	Symbol								
TYP. Zener voltage: Vz(V)		Operating resistance: $Zz(\Omega)$		Rising operating resistance: $Zz(\Omega)$		Reverse current: IR(uA)			
MIN.	MAX.	Iz(mA)	MAX.	Iz(mA)	MAX.	Iz(mA)	MAX.	VR(V)	
VDZ 3.6B	3.600	3.845	5.0	100	5.0	1000	1.0	10.0	1.0
VDZ 3.9B	3.890	4.160	5.0	100	5.0	1000	1.0	5.0	1.0
VDZ 4.3B	4.170	4.430	5.0	100	5.0	1000	1.0	5.0	1.0
VDZ 4.7B	4.550	4.750	5.0	100	5.0	800	0.5	2.0	1.0
VDZ 5.1B	4.980	5.200	5.0	80	5.0	500	0.5	2.0	1.5
VDZ 5.6B	5.490	5.730	5.0	60	5.0	200	0.5	1.0	2.5
VDZ 6.2B	6.060	6.330	5.0	60	5.0	100	0.5	1.0	3.0
VDZ 6.8B	6.650	6.930	5.0	40	5.0	60	0.5	0.5	3.5
VDZ 7.5B	7.280	7.600	5.0	30	5.0	60	0.5	0.5	4.0
VDZ 8.2B	8.020	8.360	5.0	30	5.0	60	0.5	0.5	5.0
VDZ 9.1B	8.850	9.230	5.0	30	5.0	60	0.5	0.5	6.0
VDZ 10B	9.770	10.210	5.0	30	5.0	60	0.5	0.1	7.0
VDZ 11B	10.760	11.220	5.0	30	5.0	60	0.5	0.1	8.0
VDZ 12B	11.740	12.240	5.0	30	5.0	80	0.5	0.1	9.0
VDZ 13B	12.910	13.490	5.0	37	5.0	80	0.5	0.1	10.0
VDZ 15B	14.340	14.980	5.0	42	5.0	80	0.5	0.1	11.0
VDZ 16B	15.850	16.510	5.0	50	5.0	80	0.5	0.1	12.0
VDZ 18B	17.560	18.350	2.0	65	2.0	80	0.5	0.1	13.0
VDZ 20B	19.520	20.390	2.0	85	2.0	100	0.5	0.1	15.0
VDZ 22B	21.540	22.470	2.0	100	2.0	100	0.5	0.1	17.0
VDZ 24B	23.720	24.780	2.0	120	2.0	120	0.5	0.1	19.0
VDZ 27B	26.190	27.530	2.0	150	2.0	150	0.5	0.1	21.0
VDZ 30B	29.190	30.690	2.0	200	2.0	200	0.5	0.1	23.0
VDZ 33B	32.150	33.790	2.0	250	2.0	250	0.5	0.1	25.0
VDZ 36B	35.070	36.870	2.0	300	2.0	300	0.5	0.1	27.0

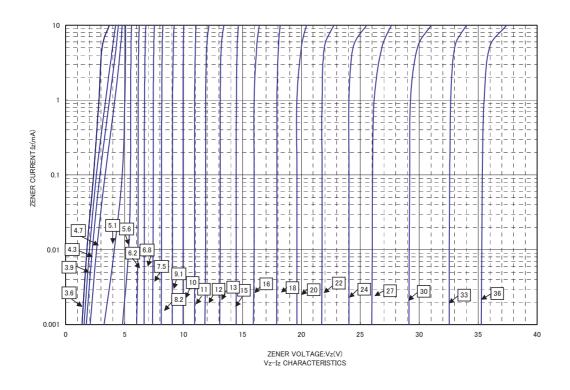
<sup>(1)</sup> The zener voltage(Vz) is measured 40ms after power is supplied.

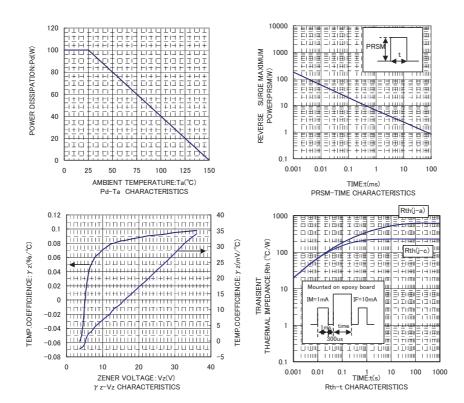
## ●Type No.

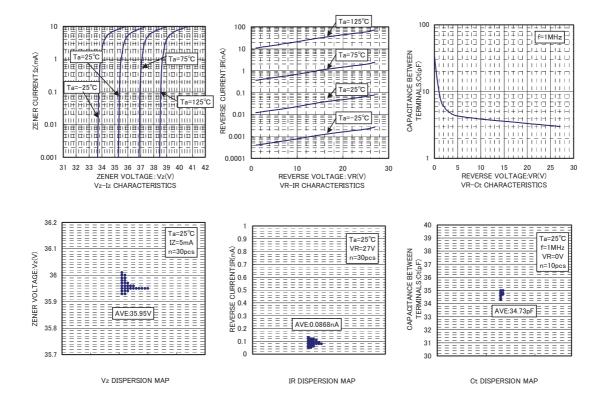
.7				
TYPE	TYPE NO.	TYPE	TYPE NO.	
VDZ 3.6B	62	VDZ 12B	25	
VDZ 3.9B	72	VDZ 13B	35	
VDZ 4.3B	82	VDZ 15B	45	
VDZ 4.7B	92	VDZ 16B	55	
VDZ 5.1B	A2	VDZ 18B	65	
VDZ 5.6B	C2	VDZ 20B	75	
VDZ 6.2B	E2	VDZ 22B	85	
VDZ 6.8B	F2	VDZ 24B	95	
VDZ 7.5B	H2	VDZ 27B	A5	
VDZ 8.2B	J2	VDZ 30B	C5	
VDZ 9.1B	L2	VDZ 33B	E5	
VDZ 10B	05	VDZ 36B	F5	
VDZ 11B	15			

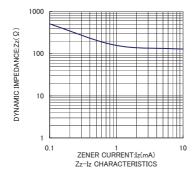
Rev.B

<sup>(2)</sup> The operating resistances(Zz,Zzk) are measured by superimposing a minute alternating current on the regulated current(Iz)









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JAPAN	USA	EU	CHINA
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CLASSIV	CLASSII	CLASSⅢ	CLASSIII

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
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  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

### **Precaution for Storage / Transportation**

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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